Overview

HP Z840 Workstation



- 1. Slimline Optical Drive Bay
- 2. 2 External 5.25" Bays
- 3. Power Button

- 4. HDD Activity LED
- 5. Front I/O: 4 USB 3.0 (Top Port has Charging Capability), 1 Headset, 1 Microphone

Overview



- 6. Choice of 850W, 88% or 1125W, 90% Efficient Power Supplies
- 7. 16 DIMM Slots for DDR4 ECC Memory
- 8. 2 External 5.25" Bays
- 9. 4 Internal 3.5" Bays
- 10. Rear I/0:

Rear Power Button

4 USB 3.0

2 USB 2.0

1 Serial

PS/2 keyboard and mouse

2 RJ-45 to integrated Gigabit LAN

1 Audio Line-In (can be retasked as microphone)

1 Audio Line-Out

11. 2 Intel Xeon Processors E5-2600 v3 family

- 12. Slot 1: PCIe Gen3 x4
 - Slot 2: PCIe Gen3 x16
 - Slot 3: PCIe Gen3 x8 Available ONLY when 2nd processor is installed
 - Slot 4: PCIe Gen3 x16 Available ONLY when 2nd processor is installed
 - Slot 5: PCIe Gen2 x4 when 1 CPU is installed. Transforms to PCIe Gen3 x8 when 2nd CPU is installed
 - Slot 6: PCIe Gen3 x16
 - Slot 7: PCIe Gen2 x1
- 13. 6 SATA, 8 SAS Ports
- 14. 2 USB 2.0 Ports, 1 USB 3.0 Port



Overview

Overview

Form Factor Operating Systems

Rackable Minitower

Preinstalled:

- Windows 7 Professional 64-bit (National Academic)
- Windows 8.1 Pro 64-bit downgrade to Windows 7 Professional 64-bit **
- Windows 8.1 Pro 64-bit 05 *
- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 6 & 7, SUSE Linux Enterprise Desktop 11 and Ubuntu 14.04)
- Red Hat Enterprise Linux (RHEL) Workstation Paper License (1yr) ***

NOTES:

For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Notes: * Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See http://www.microsoft.com.

Notes: ** This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

Notes: *** This second OS must be ordered with the HP Linux Installer Kit as the first OS.

Available Processors

Name	Clock Speed (GHz)	Cores	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology¹	TDP (W)
INTEL® XEON® E5-2699 v3 processor	2.3	18	45	2133	9.6	YES	YES	5/13	145
INTEL® XEON® E5-2697 v3 processor	2.6	14	35	2133	9.6	YES	YES	5/10	145
INTEL® XEON® E5-2695 v3 processor	2.3	14	35	2133	9.6	YES	YES	5/10	120
INTEL® XEON® E5-2687W v3 processor	3.1	10	25	2133	9.6	YES	YES	1/4	160
INTEL® XEON® E5-2690 v3 processor	2.6	12	30	2133	9.6	YES	YES	5/9	135
INTEL® XEON® E5-2667 v3 processor	3.2	8	20	2133	9.6	YES	YES	2/4	135
INTEL® XEON® E5-2683 v3 processor	2.0	14	35	2133	9.6	YES	YES	5/10	120
INTEL® XEON® E5-2680 v3 processor	2.5	12	30	2133	9.6	YES	YES	4/8	120
INTEL® XEON® E5-2670 v3 processor	2.3	12	30	2133	9.6	YES	YES	3/8	120
INTEL® XEON® E5-2643 v3 processor	3.4	6	20	2133	9.6	YES	YES	2/3	135



Overview

INTEL® XEON® E5-2660 v3 processor	2.6	10	25	2133	9.6	YES	YES	3/7	105
INTEL® XEON® E5-2650 v3 processor	2.3	10	25	2133	9.6	YES	YES	3/7	105
INTEL® XEON® E5-2637 v3 processor	3.5	4	15	2133	9.6	YES	YES	1/2	135
INTEL® XEON® E5-2640 v3 processor	2.6	8	20	1866	8.0	YES	YES	2/8	90
INTEL® XEON® E5-2630 v3 processor	2.4	8	20	1866	8.0	YES	YES	2/8	85
INTEL® XEON® E5-2623 v3 processor	3.0	4	10	1866	8.0	YES	YES	3/5	105
INTEL® XEON® E5-2620 v3 processor	2.4	6	15	1866	8.0	YES	YES	2/8	85
INTEL® XEON® E5-2609 v3 processor	1.9	6	15	1600	6.4	NO	YES	N/A	85
INTEL® XEON® E5-2603 v3 processor	1.6	6	15	1600	6.4	NO	YES	N/A	85

¹The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Quad-Core, Six-Core, Eight-Core, 10-Core, 12-Core, 14-Core, 16-Core and 18-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel® Xeon® processors E5-2637v3, E5-2643v3, E5-2670v3, E5-2680v3, E5-2683v3, E5-2667v3, E5-2687Wv3, E5-2690v3, E5-2695v3, E5-2697v3 and E5-2699v3 REQUIRE the 1125W Power Supply Option.

Form Factor Rackable Minitower

Color Black / Hematite

I/O Slots (see system board section for more details)

Slot 1: PCIe Gen3 x4 Slot 2: PCIe Gen3 x16

Slot 3: Gen3 x8 - Available ONLY when 2nd processor is installed Slot 4: Gen3 x16 - Available ONLY when 2nd processor is installed

Slot 5: PCIe Gen2 x4 when 1 CPU is installed. Transforms to PCIe Gen3 x8 when 2nd CPU is installed

Slot 6: PCIe Gen3 x16

Overview

Slot 7: PCle Gen 2x1

The PCIe x8 connectors are open ended, allowing a PCIe x16 card to be seated in the slot.

Bays (see storage section Total Bays = 7

for more details)

4 Internal 3.5" storage bays 2 External 5.25" bays

1 External Slim-line Optical bay

Internal Bays

4 internal 3.5" bays (All 4 include acoustic dampening rail assemblies)

External Bays

2 external 5.25" bays

Top bay device depth limit: 206mm Bottom bay device depth limit: 206mm

Front I/O

4 USB 3.0

1 Combo Headset 1 Microphone

Rear I/O

4 USB 3.0 2 USB 2.0

1 Serial

PS/2 keyboard and mouse 2 RJ-45 to integrated Gigabit LAN

1 Audio Line-In (can be retasked as microphone)

1 Audio Line-Out

Internal USB

2 USB 2.0 ports available with a single 2x5 header.

1 USB 3.0 port available with a shrouded 20-pin connector.

The 2x5 header can be converted to a standard (Type-A) USB connector through the use one HP Internal USB Port Kit (EM165AA). This port kit uses one half of the 2x5 header.

Chassis Dimensions (H x

W x D)

44.4 x 20.3 x 52.5 cm (17.5 x 8.0 x 20.7 in)

System Weight

Exact weights depend upon configuration.

Minimum config: 21.1kg (46.7lbs.) Typical config: 22.8kg (50.4lbs.) Maximum config: 29.2kg (64.3lbs.)

Temperature

Operating: 5° to 35°C (40° to 95°F)

Non-operating: -40° to 70°C (-40° to 158°F)

Humidity

Operating: 8% to 85% Non-operating: 8% to 90%

pressurized)

Maximum Altitude (non- Operating: 3,048m (10,000feet) Non-operating: 9,100m (30,000feet)

Power Supply

Choice of:

• 850W 88% Efficient wide-ranging, active Power Factor Correction • 1125W 90% Efficient wide-ranging, active Power Factor Correction

NOTES: The 1125W power supply can also supply 1275W of output power when the input voltage is greater than 105V. If the input voltage is less than 105V, but greater than 90V for any reason, the

Overview

maximum power that can be drawn is 1125W. An uninterruptible power supply (UPS) is highly recommended if 1275W output power is desired.

The 1125W Power Supply can also supply 1450W of output power when the input voltage is greater than 180V under all conditions.

The Z820 power supply efficiency reports can be found at these links:

850W - http://www.plugloadsolutions.com/psu_reports/HEWLETT%20PACKARD_623195- 001_EC0S%202620%201_850W_Report%20(2).pdf

1125W - http://www.pluqloadsolutions.com/psu_reports/HEWLETT%20PACKARD_623196-001_ECOS%202921_1125W_Report(1275w).pdf

Contact an HP representative for special support approval for high power configurations.

Interfaces Supported

- 6 channel SATA 6.0 Gb/s interface
- 8-channel 6 Gb SAS interface
 - 8 SAS connectors on the motherboard, SAS ports can be ported externally by using the SAS Bulkhead and/or Back Panel connector Kits
- USB 3.0, USB 2.0

Hard Drive Controller Supported Workstation ISV Certifications SATA and SAS controllers

See the latest list of certifications at

http://www.hp.com/united-states/campaigns/workstations/partnerships.html



Supported Components

Processors*		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Z840 Intel Xeon E5-2600 v3 Series CPU				
	Xeon E5-2603 v3 1.6 1600 6C CPU	Υ	Υ	J9V77AA	
	Xeon E5-2609 v3 1.9 1600 6C CPU	Υ	Υ	J9V76AA	
	Xeon E5-2620 v3 2.4 1866 6C CPU	Υ	Υ	J9V75AA	
	Xeon E5-2623 v3 3.0 1866 4C CPU	Υ	Υ	J9Q18AA	
	Xeon E5-2630 v3 2.4 1866 8C CPU	Υ	Υ	J9Q17AA	
	Xeon E5-2637 v3 3.5 2133 4C CPU	Υ	Υ	J9Q15AA	
	Xeon E5-2640 v3 2.6 1866 8C CPU	Υ	Υ	J9Q16AA	
	Xeon E5-2643 v3 3.4 2133 6C CPU	Υ	Υ	J9Q12AA	
	Xeon E5-2650 v3 2.3 2133 10C CPU	Υ	Υ	J9Q14AA	
	Xeon E5-2660 v3 2.6 2133 10C CPU	Υ	Υ	J9Q13AA	
	Xeon E5-2667 v3 3.2 2133 8C CPU	Υ	Υ	J9Q08AA	
	Xeon E5-2670 v3 2.3 2133 12C CPU	Υ	Υ	J9Q11AA	
	Xeon E5-2680 v3 2.5 2133 12C CPU	Υ	Υ	J9Q10AA	
	Xeon E5-2683 v3 2.0 2133 14C CPU	Υ	Υ	J9Q09AA	
	Xeon E5-2687Wv3 3.1 2133 10C CPU	Υ	Υ	J9Q06AA	
	Xeon E5-2690 v3 2.6 2133 12C CPU	Υ	Υ	J9Q07AA	
	Xeon E5-2695 v3 2.3 2133 14C CPU	Υ	Υ	J9Q05AA	
	Xeon E5-2697 v3 2.6 2133 14C CPU	Υ	Υ	J9Q04AA	
	Xeon E5-2699 v3 2.3 2133 18C CPU	Υ	Υ	J9Q03AA	

Intel® Xeon® processors E5-2637v3, E5-2643v3, E5-2670v3, E5-2680v3, E5-2683v3, E5-2667v3, E5-2687Wv3, E5-2690v3, E5-2695v3, E5-2697v3 and E5-2699v3 REQUIRE the 1125W Power Supply Option.

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Monitors / Displays

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Z Display Z22i 21.5-inch IPS LED Backlit Monitor			D7Q14A8	
HP Z Display Z23i 23-inch IPS LED Backlit Monitor			D7Q13A8	
HP Z Display Z24i 24-inch IPS LED Backlit Monitor			D7P53A8	
HP Z Display Z27i 27-inch IPS LED Backlit Monitor			D7P92A8	
HP Z Display Z30i 30-inch IPS LED Backlit Monitor			D7P94A8	
HP DreamColor LP2480zx Professional Display			GV546A8	
HP DreamColor Z24x Professional Display			E9Q82A8	
HP DreamColor Z27x Professional Display			D7R00A8	



Supported Components

Storage / Hard Drives

Sub-Section Description/Notes

NOTES: NCQ (Native Command Queuing) not supported in Red Hat Enterprise Linux

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

SAS Hard Drives	SAS Hard Drives for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	600GB* SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA	
	300GB* SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA	
	HP 300GB* SAS 10K SFF HDD	Υ	Υ	A2Z2OAA	
	HP 600GB* SAS 10K SFF HDD	Υ	Υ	A2Z21AA	
	HP 1.2TB* SAS 10K SFF HDD	Υ	Υ	E2P04AA	
	NOTE:				

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to 5 SATA drives, 5 SAS, drives, or 6 SATA 2.5", Small Form Factor (SFF) drives 8 port SAS Controller included on the system board

SATA Hard Drives	SATA Hard Drives for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	3.0TB* SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA	
	2.0TB* SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	1TB* SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	500GB* SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	500GB* SATA 7.2K SED SFF HDD	Υ	N	(not available today as After Market Option)	

NOTES

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Up to 5 SATA drives, 5 SAS, drives, or 6 SATA 2.5", Small Form Factor (SFF) drives

SATA Solid State Drives	SATA SSDs for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 128GB* SATA 6Gb/s SSD	Υ	Υ	A3D25AA	
	HP 256GB* SATA 6Gb/s SSD	Υ	Υ	A3D26AA	
	HP 512GB* SATA 6Gb/s SSD	Υ	Υ	D8F30AA	
	HP 1TB* SATA 6Gb/s SSD	Υ	Υ	F3C96AA	
	Samsung Enterprise 240GB* SATA SSD	Υ	Υ	F0W94AA	
	Samsung Enterprise 480GB* SATA SSD	Υ	Υ	F0W95AA	
	Intel Pro 1500 180GB* SATA SSD	Υ	Υ	F5Z70AA	



Supported Components

HP 256GB* SATA 6Gb/s SED Opal 1 SSD Y Y G7U67AA Note 1

NOTE 1:

The 256GB Self-Encrypting Drive (SED) version has similar performance to the standard 256GB SSD. It is also available in Opal 1.0 and Opal 2.0 versions

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

PCIe Solid State Drives

PCIe SSDs for HP Workstations			Option	
	Factory	Option	Kit Part	Support
	Configured	Kit	Number	Notes
HP Z Turbo Drive 512GB* SSD	Υ	Υ	G3G89AA	
HP Z Turbo Drive 256GB* SSD	Υ	Υ	G3G88AA	

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Hard Drive Controllers

Factory integrated RAID on motherboard for SATA drives	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
RAID 0 Configuration – Striped Array	Υ	N		Note 1
RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	N		Note 2
RAID 1 Configuration – Mirrored Array	Υ	N		Note 3
RAID 10 Configuration - Striped/Mirrored Array	Υ	N		
RAID 5 Configuration - Parity Array	Υ	N		Note 4
HP SAS Back Panel Connector kit	Υ	Υ		
Must have 4 or fewer SAS hard drives to configure this	option			
HP SAS Back Panel Bulkhead Connector Kit	Υ	Υ		
HP SAS Back Panel Connector kit required. Internal SAS	S HD drives are no	t supported		
LSI iBBU09 Battery Backup Unit	Υ	Υ	E0X19AA	
LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	E0X21AA	
Integrated LSI SAS 2308 Controller with RAID 0/1/1E/10	Υ	N		
Integrated SATA 6.0 Gb/s Controller	Υ	N		

NOTE 1: Minimum of 2 hard drives needed. All hard drives must be identical (size/speed/type/bus/functional capabilities). Must have 2, 3 or 4 HD Drives.

NOTE 2: Minimum of 3 SATA hard drives needed. All hard drives must be identical (size/speed/type/bus/functional capabilities).

At least 3 HD Drives required. May have 4th and 5th HD Drives. Drives must be the same drive (size/speed/type/functional capability).

NOTE 3: 2 SATA or 2 SAS hard drives required. All hard drives must be identical (size/speed/type/bus/functional capabilities).

NOTE 4: Minimum of 3 SATA hard drives needed. All SATA hard drives must be identical (size/speed/type/bus/functional capabilities). Must have 3 or 4 HD Drives. 5 HD Drives not allowed.

Supported Components

NOTE: SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.

LSI RAID Definitions:

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux_hardware_matrix for details

Graphics

	P	0-4	Option		Suppo	rted
	Factory Configured	Option Kit	Kit Part Number	Support Notes	# of cards	Mixed?
Professional 2D						
NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA	Note 1	4	
NVIDIA NVS 315 1GB Graphics (for HP Workstations)	Υ	Υ	E1U66AA	Note 1	4	
NVIDIA NVS 510 2GB Graphics	N	Υ	C2J98AA	Note 2	2	
Entry 3D						
NVIDIA Quadro K420 1GB Graphics	Υ	Υ	J3G86AA		2	
NVIDIA Quadro K620 2GB Graphics	Υ	Υ	J3G87AA		2	
AMD FirePro W2100 2GB Graphics	Υ	Υ	J3G91AA		2	
Mid-range 3D						
AMD FirePro W5100 4GB Graphics	Υ	Υ	J3G92AA		2	
NVIDIA Quadro K2200 4GB Graphics	Υ	Υ	J3G88AA		2	
High End 3D						
NVIDIA Quadro K4200 4GB Graphics	Υ	Υ	J3G89AA		2	
NVIDIA Quadro K5200 8GB Graphics	Υ	Υ	J3G90AA		2	
NVIDIA Quadro K6000 12GB Graphics	Υ	Υ	C2J96AA		2	

For configurations not listed in this specification, please contact the factory for review

NOTE 1: 3rd and 4th graphics possible by using Option Kits.

NOTE 2: NVIDIA NVS 510 graphics available by using Option Kits only.

Memory	DDR4-2133 ECC Registered DIMMs	Option Kit Part Number	Support Notes
СТО	4GB DDR4-2133 ECC Registered RAM	J9P81AA	
	8GB DDR4-2133 ECC Registered RAM	J9P82AA	
	16GB DDR4-2133 ECC Registered RAM	J9P83AA	
	32GB DDR4-2133 ECC Load Reduced (LR) RAM	J9P84AA	

NOTES:

Identical memory components are used to build the CTO configurations as are available as After Market



Supported Components

Options (AMO). The AMO Option Kit Part # are shown alongside the memory DIMMs

For details on the supported memory configurations on the HP Z840 Workstation, please refer to the System Technical Specifications - System Board section of this document.

DIMMs should be equally distributed across all four memory channels for optimal performance.

Each processor supports up to 4 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. For example, if a 1600MHz capable CPU is used in the system, the maximum speed the memory will run at is 1600MHz regardless of the specified speed of the memory.

You cannot intermix LR DIMMs with Registered DIMMs. The system will not work.

Maximum memory capacities assume Windows 64-bit operating systems or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resources.

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Thin USB Powered Speakers	N	Υ	KK912AA	
Integrated IDT 92HD94 Audio	Υ	N	NA	

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim SuperMulti DVD Writer	Υ	Υ	K3R64AA	
HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA	Note 1
HP 9.5mm Slim BDXL Blu-Ray Writer	Υ	Υ	K3R65AA	Note 2
HP 15-in-1 Media Card Reader				
HP DX115 Removable HDD Frame/Carrier	N	Υ	FZ576AA	
HP DX115 Removable Drive Enclosure				
HP 15-in-1 Media Card Reader	Υ	Υ	F4N90AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd drive option.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.



Supported Components

Controller Cards

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP IEEE 1394b FireWire® PCIe Card	Υ	Υ	NK653AA	
HP Thunderbolt [™] -2 PCIe 1-port I/O Card*	Υ	Υ	F3F43AA	

Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP X520 10GbE Dual Port Adapter	Υ	Υ	C3N52AA	
HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	
Intel Ethernet I210-T1 PCIe NIC	Υ	Υ	E0X95AA	
Intel 7260 802.11 a/b/g/n PCIe WLAN NIC	N	Υ		
Integrated Intel I210AT PCIe GbE Controller	Υ	N		Note 1
Integrated Intel I218LM PCIe GbE Controller	Υ	N		Note 1
HP 361T PCIe Dual Port Gigabit NIC	Υ	Υ	C3N37AA	Note 1

NOTE 1: "Gigabit" or "GbE" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

*Wireless access point and internet service required. Availability of public wireless access points limited.

Racking and Physical Security

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Security Cable with Kensington Lock	N	Υ	PC766A	
HP Chassis Intrusion Sensor	Υ	N		Standard on all systems
HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	N	Y	B8S55AA	

Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP USB Smart Card Keyboard	Υ	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	N	Υ	WH343AA	
	HP PS/2 Keyboard	Υ	Υ	QY774AA	
	HP PS/2 Mouse	Υ	Υ	QY775AA	
	HP USB Keyboard	Υ	Υ	QY776AA	
	HP USB Optical Mouse	Υ	Υ	QY777AA	
	HP USB 1000dpi Laser Mouse	Υ	Υ	QY778AA	

Other Hardware Factory Option Kit Option Kit Part Support



Supported Components

	Configured		Number	Notes
HP Internal USB Port Kit	N	Υ	EM165AA	Note 1
HP SAS Back Panel Connector Kit	N	Υ	EM164AA	
HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	Note 2
HP Power Cord Kit	Υ	N		
HP Workstation Mouse Pad	Υ	N		Japan Only
HP Optical Bay HDD Mounting Bracket	N	Υ	NQ099AA	
HP ENERGY STAR® Qualified Configuration	Υ	N		

NOTE 1: The HP Internal USB Port kit has a single USB 2.0 type A connector.

NOTE 2: No hot plug / hot swap supported with eSATA

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		Note 1
	HP Remote Graphics Software (RGS) 6.0	Υ	Υ		Note 2
	MS Office Home & Business 2013	Υ	N		Note 3
	Cyberlink PowerDVD and Power2Go	Υ	N		
	Foxit PhantomPDF Express	Υ	N		

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports Windows 7, Windows 8.1, SLED 11, and RHEL v6.5

NOTE 3: Must be selected as a Configure to Order option. Delivered in the form of a "Drop in the Box"

Operating Systems

Windows 8.1 Pro 64-bit*

Windows 7 Professional 64-bit (available through downgrade rights from Windows 8.1 64-bit)**
Windows 7 Professional (MSNA) 64-Bit*

HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)¹

NOTE 1: This second OS must be ordered with the HP Linux Installer Kit as the first OS.

^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See http://www.microsoft.com.

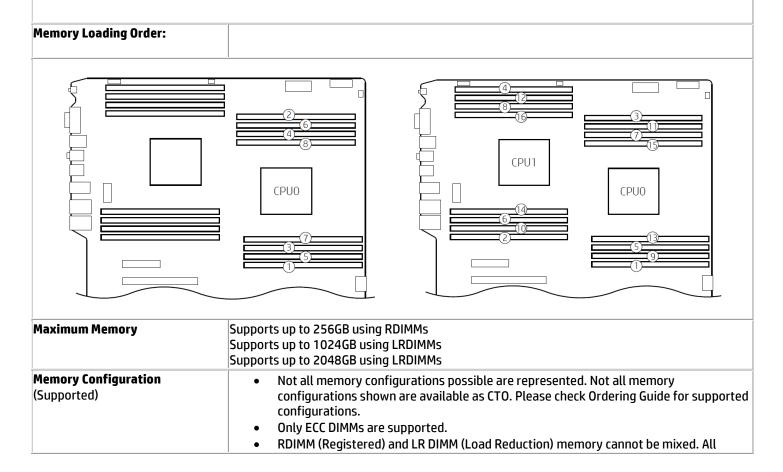
^{**} This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

System Board	
System Board Form Factor	Custom Form Factor, 13" x 14.25" (330.20mm x 361.95mm)
Processor Socket	Dual LGA2011-3
CPU Bus Speed	QPI: Up to 9.6GT/sec, dual link implementation
Chipset	Intel® C612 Chipset
Super I/O Controller	Nuvoton NPCD379H
Memory Expansion Slots	16 slots (8 slots per CPU)
Memory Type Supported	DDR4 R-DIMM (Registered), ECC: 4GB, 8GB, and 16GB DDR4 LR-DIMM (Load Reduced), ECC: 32GB (64GB and 128GB added after initial release)
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1600MHz, 1866MHz, and 2133MHz

			Single Processor CPU0							
Capacity	Notes	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6	DIMM7	DIMM8	Rating
4GB	*	4GB								Fair
8GB		4GB 8GB							4GB	Good Fair
12GB		4GB		4GB					4GB	Better
16GB		4GB 8GB		4GB			4GB		4GB 8GB	Best Good
32GB		4GB 8GB 16GB	4GB	4GB 8GB	4GB	4GB	4GB 8GB	4GB	4GB 8GB 16GB	Best Best Good
48GB	~	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	Best
64GB		8GB 16GB	8GB	8GB 16GB	8GB	8GB	8GB 16GB	8GB	8GB 16GB	Best Best
96GB	~	16GB	8GB	16GB	8GB	8GB	16GB	8GB	16GB	Best
128GB		16GB 32GB	16GB	16GB 32GB	16GB	16GB	16GB 32GB	16GB	16GB 32GB	Best Best
256GB	~	32GB 64GB	32GB	32GB 64GB	32GB	32GB	32GB 64GB	32GB	32GB 64GB	Best Best
512GB	~ ~	64GB 128GB	64GB	64GB 128GB	64GB	64GB	64GB 128GB	64GB	64GB 128GB	Best Best
1TB	~	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	Best



			Dual Processor															
			СРИО							CPU1								
Capacity (GB)	Notes	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	Rating
8GB		4GB								4GB								Fair
16GB		4GB 8GB							4GB	4GB 8GB							4GB	Good Fair
32GB		4GB 8GB 16GB		4GB			4GB		4GB 8GB	4GB 8GB 16GB		4GB			4GB		4GB 8GB	Best Good Fair
64GB	~	4GB 8GB	4GB	4GB 8GB	4GB	4GB	4GB 8GB	4GB	4GB 8GB	4GB 8GB	4GB	4GB 8GB	4GB	4GB	4GB 8GB	4GB	4GB 8GB	Best Best
96GB		8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	Best
128GB	۲	8GB 16GB 32GB	8GB	8GB 16GB	8GB	8GB	8GB 16GB	8GB	8GB 16GB 23GB	8GB 16GB 32GB	8GB	8GB 16GB	8GB	8GB	8GB 16GB	8GB	8GB 16GB 32GB	Best Best Good
192GB		16GB 16GB	8GB 16GB	16GB 16GB	8GB	8GB	16GB 16GB	8GB 16GB	16GB 16GB	16GB 16GB	8GB 16GB	16GB 16GB	8GB	8GB	16GB 16GB	8GB 16GB	16GB 16GB	Best Better
256GB	۲	16GB 32GB	16GB	16GB 32GB	16GB	16GB	16GB 32GB	16GB	16GB 32GB	16GB 32GB	16GB	16GB 32GB	16GB	16GB	16GB 32GB	16GB	16GB 32GB	Best Best
512GB	۲	32GB 64GB	32GB	32GB 64GB	32GB	32GB	32GB 64GB	32GB	32GB 64GB	32GB 64GB	32GB	32GB 64GB	32GB	32GB	32GB 64GB	32GB	32GB 64GB	Best Best
1TB	~	64GB 128GB	64GB	64GB 128GB	64GB	64GB	64GB 128GB	64GB	64GB 128GB	64GB 128GB	64GB	64GB 128GB	64GB	64GB	64GB 128GB	64GB	64GB 128GB	Best Best
2TB		128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	Best
Slot Lo		1	9	5	13	15	7	11	3	2	10	6	14	16	8	12	4	





System reclimed Spec		
	 Do not install me installed. Dual processor of is not supported. The Z840 will su initial Z840 release. 	apport up to 512GB at initial release. Apport up to 1024GB when 64GB DIMM support is added following Asse. Apport up to 2048GB when 128GB DIMM support is added following
PCI Express Connectors	One PCIe Gen3 x8 open-e • Enabled only wit One PCIe x8 open-ended • Enabled for One	atch. th optional 2nd CPU is installed. ended connector. th optional 2nd CPU is installed. connector. PCIe Gen2 x4 slot with 1 CPU PCIe Gen3 x8 with optional 2nd CPU installed
Supported Drive Interfaces		
		Factory integrated RAID is Microsoft Windows only. External SATA (eSATA)* Supported on all SATA and sSATA ports configurable with optional eSATA* After-Market Option cable kit) * hot plug / hot swap not supported with eSATA External SATA (eSATA)* Supported on all SATA and sSATA ports configurable with optional eSATA* After-Market Option cable kit) * hot plug / hot swap not supported with eSATA
	Serial Attached SCSI	Integrated 8-channel SAS 6.0Gb/sec controller with HW RAID 0, 1, 10
	Integrated RAID	SATA: RAID 0, 1 (Supports one RAID) SATA: RAID 0, 1, 5, 10 (Supports up to 2 RAIDs) SAS: HW RAID 0, 1, 10 (Supports up to 2 RAIDs)
	Integrated Graphics	None
	Network Controller	Integrated Intel I218LM Memory Integrated 3KB receive buffer and 3KB transmit buffer Data rates supported: 10/100/1000 Mb/s Compliance IEEE 802.1as, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i 802.3u, 802.3x, 802.3z Bus architecture PCIe 1.0 x1 and SMBus Power requirement 0.5 watts Boot ROM support Network transfer rates:



-		
	PCI-X Connectors	10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 200 Mb/s 100BASE-TX (full-duplex) 2000 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s Management capabilities: WOL, auto MDI crossover, PXE, Multiport teaming, RSS, Advanced cable diagnostics AMT 9.1 support, vPro compliant Integrated I210AT Adjustable FIFO packet buffer memory up to 24KB Tx, 16KB Rx Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.1as, 802.1q, 802.1Q, 802.3, 802.3ab, 802.3ap, 802.3az, 802.3u, 802.3x, 802.3z Bus architecture PCIe 1.0 x1 and SMBus Boot ROM support Network transfer rates: 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (full-duplex) 100 Mb/s 100BASE-TX (full-duplex) 2000 Mb/s 1000BASE-TX (full-duplex) 2000 Mb/s Management capabilities: WOL, auto MDI crossover, PXE, Multiport teaming, RSS, Advanced cable diagnostics
	PCI Card Guide	Yes
	Wake on LAN	Yes, both ports
	Integrated Trusted Platform Module	Infineon TPM 1.2 Certified (TPM2.0 Certified, Hardware Enabled; Not Available at Initial Release)
IEEE 1394 Connector(s)	Front	None
	Rear	None
	Internal	None
USB Connector(s)	Front	4 USB 3.0
	Rear	4 USB 3.0 2 USB 2.0
	Internal	1 USB 3.0 available with a single 20-pin shrouded connector. This header supports a USB Media Card reader.
		2 USB 2.0 port available with one 2x5 header. This header supports an HP Internal USB Port Kit (EM165AA) to provide a single USB Type-A connector. This port kit uses one half of the 2x5 header. Third party adapters are also available.
HD Integrated Audio	Realtek ALC221	supports an HP Internal USB Port Kit (EM165AA) to provide a single USB Type-A connector. This port kit uses one half of the 2x5 header.
HD Integrated Audio Flash ROM	Realtek ALC221 Yes	supports an HP Internal USB Port Kit (EM165AA) to provide a single USB Type-A connector. This port kit uses one half of the 2x5 header.



Chassis Fan Header	One Chassis	ne Chassis Fan Header					
Front PCI Fan Header	2 Front PCI	Front PCI Fan Headers					
Front Control Panel/Speaker Header	Yes	es					
CMOS Battery Holder - Lithium	Yes						
Power Supply Headers	Yes						
Power Switch, Power LED & Hard Drive LED Header		r switch, front powe eader on system bo		D. Rear power switch	and rear power LED.		
Clear Password Jumper	Yes						
Serial Port	Yes, on rea	r panel					
Parallel Port	No						
Keyboard/Mouse	Yes						
Power Supply		850W 88% Efficie (Wide-Ranging	'	90% Efficient	5W*/1450W* , Custom PSU g, Active PFC)		
Operating Voltage Range		90-26	9 VAC	90-26	9 VAC		
Rated Voltage Range		100-127 VAC 200-240 VAC	118 VAC	100 VAC 115-127 VAC 200-240 VAC	118 VAC		
Rated Line Frequency		50-60 Hz	400 Hz	50-60 Hz	400 Hz		
Operating Line Frequency Range		47-66 Hz	393-407 Hz	47-66 Hz	393-407 Hz		
Rated Input Current		11A @ 100-127 VAC 5.5A @ 200-240 VAC	11A @ 118 VAC	12A @ 100 VAC 12A @ 115-127 VAC 10A @ 200-240 VAC	12A @ 118 VAC		
Heat Dissipation (Configuration a software dependent)	nd	Typical = 2142 btu/hr (540kg-cal/hr) Max = 3335 btu/hr (840 kg-cal/hr)		Typical = 2773 btu/hr (699 kg-cal/hr) Max-1 = 3878 btu/hr (977 kg-cal/hr) Max-2 = 5002 btu/hr (1260 kg-cal/hr) Max-3 = 5624 btu/hr (1417 kg-cal/hr)			
Power Supply Fan		(2) 80x25 mm v	ariable speed	(2) 80x25 mm variable speed			
ENERGY STAR Qualified		Ye	!S	Υ	es		
(Configuration dependent)							
Power Supply Efficiency		88% Ef	ficient				
				90% Efficient			
		The Z840 850W		TI 70404477W			
		efficiency report ca		The Z840 1125W power supply efficiency report can be found at this link: TBD			
		uiik.	100	report can be roui	iu at tilis tilik. TDD		
FEMP Standby Power Compliant @)115V	Ye	.c	V	 es		
(<2W in S5 - Power Off)				•			
EuP Compliant @ 230V		Yes Yes			es		
(<0.5 W in S5 - Power Off)							
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)		Yes; Configuration dependent Yes; Configuration		tion dependent			
Power Consumption in sleep mode (as defined by ENERGY STAR) - Sus RAM (S3) (Instantly Available PC)		<15	5W	<3	5W		
Built-in Self-Test LED		Ye	<u> </u>	V	 es		
Dance in Jeli-1630 LLD		1					



System Technical Specifications

Surge Tolerant Full Ranging Power (withstands power surges up to 20		Yes	Yes				
*Input voltage restriction							
	voltage is g any reason, (UPS) is hig The 1125W	TE: The 1125W power supply can also supply 1275W of output power when the input tage is greater than 105V. If the input voltage is less than 105V, but greater than 90V for reason, the maximum power that can be drawn is 1125W. An uninterruptible power supp S) is highly recommended if 1275W output power is desired. 1125W Power Supply can also supply 1450W of output power when the input voltage is ater than 180V under all conditions.					
AUX IN (audio)	No						
Clear CMOS Button	Yes						
Multibay Header	No						
Integrated Gigabit Ethernet	Yes, dual po	ort.					
Access Panel Solenoid Lock Header	No						
Access Panel Intrusion Sensor Header	Yes, as part of Front UI (Control Panel) cable header						
Memory Fan Connector	Yes, blind-r	nate					

SYSTEM CONFIGURATION

Example Configuration	Processor Info	1x Intel Xeor	n E5-2609v3	(Six-Core) 85	5W		
#1	Memory Info	16GB DDR4-	2133 (2x8GB) 1CPU RegR	AM		
	Graphics Info	1x NVIDIA Qu	uadro K620				
	Disks/Optical/Floppy	1x 500GB SA	TA 7200/1x I	DVD-ROM SA	TA		
	Power Supply	850W 88% C	ustom PSU				
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	103.	41 W	102.	23 W	103.	92 W
	Windows Busy Typ (S0)	183.75 W		181.88 W		189.37 W	
	Windows Busy Max (S0)	204.93 W		201.28 W		206.74 W	
	Sleep (S3)	3.711 W	3.587 W	3.785 W	3.711 W	3.587 W	3.785 W
	Off (S5)	1.053 W	0.992 W	1.159 W	1.053 W	0.992 W	1.159 W
	Zero Power Mode (ErP)	0.18	32 W	0.29	98 W	0.17	72 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	352.83	btu/hr	348.81	btu/hr	354.58	btu/hr
	Windows Busy Typ (S0)	626.96	btu/hr	620.57 btu/hr		646.13 btu/hr	
	Windows Busy Max (S0)	699.22	! btu/hr	686.77	' btu/hr	705.40	btu/hr
	Cloop (C2)	12.66	12.24	12.91	12.66	12.24	12.91
	Sleep (S3)	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr
	Off (S5)	3.59 btu/hr	3.38 btu/hr	3.95 btu/hr	3.59 btu/hr	3.38 btu/hr	3.95 btu/hr
	Zero Power Mode (ErP)	0.621	btu/hr	1.018	btu/hr	0.586	btu/hr

Example Configuration	Processor Info	2x Intel Xeon E5-2640v3 (Eight-Core) 90W
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#2	Memory Info	32GB DDR4-2133 (8x4GB) 2CPU RegRAM						
(ENERGY STAR QUALIFIED)	Graphics Info	1x NVIDIA Qu	ıadro K2200					
	Disks/Optical/Floppy	3x 500GB SA	TA 7200/1x l	DVD-ROM SA	TA			
	Power Supply	1125W 90% Custom PSU						
	Other	-						
Energy Consumption		115	VAC	230	VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	1242	.17 W	141.	01 W	142.	47 W	
	Windows Busy Typ (S0)	324.	18 W	320.	33 W	323.	91 W	
	Windows Busy Max (S0)	398.27 W		396.25 W		398.75 W		
	Sleep (S3)	6.08 W	6.03 W	6.13 W	6.08 W	6.03 W	6.13 W	
	Off (S5)	1.04 W	0.99 W	1.10 W	1.04 W	0.99 W	1.10 W	
	Zero Power Mode (ErP)	0.18	31 W	0.30)8 W	0.17	172 W	
Heat Dissipation**		115	VAC	230	VAC	100	VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	485.08	btu/hr	481.13	btu/hr	486.11	btu/hr	
	Windows Busy Typ (S0)	1106.10) btu/hr	1092.97	7 btu/hr	1105.18	3 btu/hr	
	Windows Busy Max (S0)	1358.90) btu/hr	1352.0	1 btu/hr	1360.5	4 btu/hr	
	Cl (C2)	20.75	20.57	20.91	20.75	20.57	20.91	
	Sleep (S3)	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	
	Off (S5)	3.55 btu/hr	3.38 btu/hr	3.76 btu/hr	3.55 btu/hr	3.38 btu/hr	3.76 btu/hr	
	Zero Power Mode (ErP)	rP) 0.619 btu/hr 1.051 btu/hr 0.5				0.587 btu	87 btu/hr btu/hr	

Example Configuration	Processor Info	2x Intel Xeor	n E5-2680v3	(12-Core) 12	0W			
#3	Memory Info	64GB DDR4-2133 (8x8GB) 2CPU RegRAM						
	Graphics Info	1x NVIDIA Qu	iadro K4200					
	Disks/Optical/Floppy	2x 300GB SA	S 15K/1x Su _l	oerMulti DVD	RW SATA			
	Power Supply	1125W 90%	Custom PSU					
	Other	-						
Energy Consumption		115	VAC	230	VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	123.	26 W	121.	121.40 W 124.07 W		07 W	
	Windows Busy Typ (S0)	413.33 W		393.34 W		412.26 W		
	Windows Busy Max (S0)	496.46 W		483.26 W		498.07 W		
	Sleep (S3)	7.114 W	7.086 W	7.148 W	7.114 W	7.086 W	7.148 W	
	Off (S5)	1.054 W	0.993 W	1.161 W	1.054 W	0.993 W	1.161 W	
	Zero Power Mode (ErP)	0.18	31 W	0.30)7 W	0.17	77 W	
Heat Dissipation**		115	VAC	230	VAC	100	VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	420.56	btu/hr	414.22	btu/hr	423.33	btu/hr	
	Windows Busy Typ (S0)	1410.28	3 btu/hr	1342.08	3 btu/hr	1406.63	3 btu/hr	
	Windows Busy Max (S0)	1693.9	5 btu/hr	1648.88	3 btu/hr	1700.10 btu/hr		
	Cloop (C2)	24.27	24.17	24.39	24.27	24.17	24.39	
	Sleep (S3)	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	



Off (CL)	3.597	3.388	3.962	3.597	3.388	3.962
Off (S5)	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr
Zero Power Mode (ErP)	0.619	btu/hr	1.049	btu/hr	0.607 btu	/hr btu/hr

Example Configuration	Processor Info	2x Intel Xeor	n E5-2697v3	(14-Core) 14	5W		
#4	Memory Info	64GB DDR4-					
	Graphics Info	2x NVIDIA Qu			<u> </u>		
	Disks/Optical/Floppy	4x 300GB SA	S 15K/1x Suj	oerMulti DVD	RW SATA		
	Power Supply	1125W 90%	Custom PSU				
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	141.	75 W	140.	45 W	141.	63 W
	Windows Busy Typ (S0)	510.66 W		498.90 W		510.82 W	
	Windows Busy Max (S0)	569.34 W		559.38 W		568.48 W	
	Sleep (S3)	6.454 W	3.669 W	6.497 W	6.454 W	3.669 W	6.497 W
	Off (S5)	1.105 W	0.987 W	1.165 W	1.105 W	0.987 W	1.165 W
	Zero Power Mode (ErP)	0.18	30 W	0.30)6 W	0.17	'8 W
Heat Dissipation**							
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	483.65	btu/hr	497.22	btu/hr	483.24	btu/hr
	Windows Busy Typ (S0)	1742.3	7 btu/hr	1702.25 btu/hr		1742.9	1 btu/hr
	Windows Busy Max (S0)	1942.29	9 btu/hr	1908.60	0 btu/hr	1939.6	5 btu/hr
	Sleep (S3)	22.02 btu/hr	21.63 btu/hr	22.16 btu/hr	22.02 btu/hr	21.63 btu/hr	22.16 btu/hr
	Off (S5)	3.77 btu/hr	3.37 btu/hr	3.97 btu/hr	3.77 btu/hr	3.37 btu/hr	3.97 btu/hr
	Zero Power Mode (ErP)	0.616	btu/hr	1.046	btu/hr	0.608	btu/hr

Example Configuration #5	Processor Info	2x Intel Xeon 2687Wv3 (10-Core) 160W						
(ENERGY STAR QUALIFIED)	Memory Info	512GB DDR4	-2133 (16x3	2GB) 2CPU LF	RAM			
	Graphics Info	2x NVIDIA Qu	iadro K6000					
	Disks/Optical/Floppy	6x 300GB 10	K SAS SFF/1x	SuperMulti I	DVDRW SATA			
	Power Supply	1125W 90%	Custom PSU					
	Other	-						
Energy Consumption		115	VAC	230	VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	On-Idle	174.	56 W	173.	77 W	175.	26 W	
	(ENERGY STAR® Idle (SO))							
	ENERGY STAR® PMAX Windows running Linpack and Viewperf	55115511			567.	75 W		
	ENERGY STAR® "Sleep" (S3)	16.426 W	16.279 W	16.099 W	16.426 W	16.279 W	16.099 W	
	ENERGY STAR® "Standby"	1.047 W	0.997 W	1.144 W	1.047 W	0.997 W	1.144 W	



System Technical Specifications

	(Off) (S5)						
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	On-Idle (ENERGY STAR® Idle (SO))	[®] PMAX 1917.48 btu/hr 1908.09 btu/hr				btu/hr	
	ENERGY STAR® PMAX Windows running Linpack and Viewperf			9 btu/hr	1937.10	5 btu/hr	
	ENERGY STAR® "Sleep" (S3)	56.046 btu/hr	55.545 btu/hr	54.935 btu/hr	56.046 btu/hr	55.545 btu/hr	54.935 btu/hr

DECLARED NOISE EMISSIONS (ENTRY-LEVEL AND HIGH-END CONFIGURATIONS)

System Configuration	Processor Info	-
(Entry level)	Memory Info	-
	Graphics Info	-
	Disks/Optical/Floppy	-

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	-	-
	Hard drive Operating (random reads)	-	-
	DVD-ROM Operating (sequential reads)	-	-

System Configuration (High-end)	Processor Info	-
	Memory Info	-
	Graphics Info	-
	Disks/Optical/Floppy	-

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	-	-
	Hard drive Operating (random reads)	-	-
	DVD-ROM Operating (sequential reads)	-	-

ENVIRONMENTAL DATA

Environmental Requirements	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F)
	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing



System Technical Specifications

Maximum Altitude	Operating: 3,000 m (10,000 feet) Non-operating: 9,100 m (30,000 feet)
Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.
Cooling	Above 1524 m (5000 ft.) altitude, maximum operating temperature is derated by 1° C (1.8° F) per 305 m (1000 ft.) elevation increase

PHYSICAL SECURITY AND SERVICEABILITY

Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less, retained by Front PCI Card Guide
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	No
Rear Port Control Cover	No
Serial, Parallel, USB, Audio, Network,	Yes



Enable/Disable Port Control		
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)	
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation	
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration	
3.3V Aux Power LED on System PCA	No	
NIC LEDs (integrated) (Green & Amber)	Yes	
CPUs and Heatsinks	A torx driver (T15) is needed to remove the CPU heatsink(s) before the CPU can be removed. CPU removal is tool-less	
Power Supply Diagnostic LED	Yes	
Front Power Button	Yes	
Front Power LED	Yes, white (normal), red (fault)	
Front Hard Drive Activity LED	Yes, white	
Front ODD Activity LED	Yes	
Internal Speaker	Yes	
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS	
Cooling Solutions	Air cooled forced convection	
Power Supply Fans	2x - 80mm x 25mm	
CPU Heatsink Fan	92 x 25mm 5-wire PWM for each CPU	
Chassis Fan	Rear: 2x - 92mm x 25mm Front (850W config): 1x - 92mm x 25mm (upper position) Front (1125W config): 2x - 92mm x 25mm	
Memory Heatsink Fan	3x - 75 x 90 x 35mm memory blowers 80 x 25 mm 4-wire PW fan	
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:	
	 Run diagnostics View the hardware configuration of the system 	
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision Diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are:	
	 Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance 	



System Technical Specifications

	Sending configuration information to another location for more in-depth analysis	
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including optical and floppy drives	
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).	
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 	
Frusted Platform Module Chip	Yes	
Integrated Chassis Handles	Yes, front and rear	
Power Supply	Tool-less, direct-connect (blind-mate)	
PCIe Card Retention	Yes, rear (all), middle (full-height cards), front (full-length with extender cards)	
Flash ROM	Yes. SPI ROM	
Diagnostic Power Switch LED on board	Yes	
Clear Password Jumper	Yes	
Clear CMOS Button	Yes	
CMOS Battery Holder	Yes	
DIMM Connectors	Yes	

BIOS

BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4.	
	BIOS supports 32 and 64-bit Operating systems.	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.	
BBS	BIOS Boot Specification v1.01	
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.	
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	
BIOS Power On	Users can define a specific date and time for the system to power on.	
ROM Based Computer Setup Utility (F10)	Review and customize system settings controlled by the BIOS.	
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Replicated Setup	Saves BIOS settings to diskette or USB flash drive in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 setup).	
SMBIOS	System Management BIOS 2.7, for system management information	
Boot Control	Disables the ability to boot from removable media on supported devices.	



Memory Change Alert	Alerts management console if memory is removed or changed.	
Thermal Alert	Monitors the temperature state within the chassis. Three modes: - NORMAL - normal temperature ranges. - ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. - SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.	
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.	
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and wake from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-Bit operating systems.	
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.	
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.	
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.	
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.	
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.	
System board revision level	Allows management SW to read the revision level of the system board Revision level is digitally encoded into the HW and cannot be modified.	
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.	
Auto Setup when new hardware installed	System automatically detects addition of new hardware.	
Keyboard-less Operation	The system can be booted without a keyboard.	
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memory.	
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.	
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics.	
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED.	
Industry Standard Specification Support		
Industry Standard	Revision Supported by the BIOS	
UEFI Specification Revision	2.3.1	
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c	
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b	



System Technical Specifications

CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification
	Universal Serial Bus Revision 3.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.7
	External BIOS Simulator found at: http://h20464.www2.hp.com/index.html

External BIOS Simulator found at: http://h20464.www2.hp.com/index.html

Social and Environmental Responsibility

	•
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: • ENERGY STAR® (energy-saving features available on selected configurations-Windows only) • US Federal Energy Management Program (FEMP) • China Energy Conservation Program • The ECO Declaration (TED)
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal The battery in this product does not contain:
	 Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight
Restricted Material Usago	This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to

System Technical Specifications

	exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.	
Low Halogen Statement	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: 3 ½" SAS HDDs, LSI 9260-8i SAS 6Gb/s ROC RAID Card, Creative Recon3D PCIe Audio Card, Liquid Cooling Solution and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.	
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.	
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html	
	Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates:	
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html	
Additional Information	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. 	
	 This product is >90% recycle-able when properly disposed of at end of life. EPEAT Gold - ENERGY STAR qualified configurations of this product are in compliance with the IEEE 1680 (EPEAT) standard at the Gold level where HP registers workstation products. See http://ww2.epeat.net/CompanyDetail.aspx?CompanyID=24 for registration status in your country. 	
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/qlobalcitizenship/society/qen_specifications.html	
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) 	
	 Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials 	
	 All packaging material is recyclable All packaging material is designed for ease of disassembly 	
	 Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting 	
Packaging Materials		
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).	
External	Outer carton, accessories carton, and insert made of corrugated paper board.	

MANAGEABILITY

Industry Standard	This product meets the following industry standard specifications for manageability functionality:	
Specifications		



	DASH 1.1 (via Intel LAN on motherboard)
Intel Active Management Technology (AMT)	Intel® Active Management Technology (AMT) 9.1 An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.1 includes the following advanced management functions: Power Management (on, off, reset, graceful shutdown, sleep and hibernate) Support in Max Power Savings (Shutdown and Hibernate Modes) Hardware Inventory (includes BIOS and firmware revisions) Hardware Alerting Agent Presence System Defense Filters Serial Over LAN (SOL) IDE Redirect ME Wake-on-LAN (WOL) DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration Management Engine (ME) firmware roll back
Intel® vPro™ Technology	Local Time Sync to UTC Remote Memory Dump Command – Creates memory dump for debug The HP Z840 Workstation supports Intel vPro technology when configured as outlined below:
	 Intel® Xeon® processor E5-1600 v3 product family or E5-2600 v3 product family featuring Intel® vPro™ Technology Intel® C610 chipset Intel® I218LM GbE LAN
Remote Manageability Software Solutions	The HP Z840 Workstation is supported on the following remote manageability software consoles: • LANDesk Management Suite (HP recommended solution) • Microsoft System Center Configuration Manager • HP Client Automation Enterprise For questions or support for manageability needs, please visit http://www.hp.com/qo/easydeploy
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers onsite, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and



System Technical Specifications

service offering.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. **NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services are extended service contracts that go beyond the standard limited warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering	
	J6F75AV	Intel Xeon E5-2620v3 2.4 1866 6C 1stCPU	
	J6F73AV	Intel Xeon E5-2630v3 2.4 1866 8C 1stCPU	
	J6F71AV	Intel Xeon E5-2637v3 3.5 2133 4C 1stCPU	
	J6F94AV	Intel Xeon E5-2620v3 2.4 1866 6C 2ndCPU	
	J6F92AV	Intel Xeon E5-2630v3 2.4 1866 8C 2ndCPU	
	J6F90AV	Intel Xeon E5-2637v3 3.5 2133 4C 2ndCPU	
Hard Drives	Product #	Offering	
	J3K71AV	500GB 7200 RPM SATA 1st HDD	
	J3K72AV	1TB 7200 RPM SATA 1st HDD	
	J3K79AV	256GB SATA 1st SSD	
	J3K92AV	500GB 7200 RPM SATA 2nd HDD	



Stable & Consistent	Offerings	
	J3K93AV	1TB 7200 RPM SATA 2nd HDD
	J3L00AV	256GB SATA 2nd SSD
	J3L13AV	500GB 7200 RPM SATA 3rd HDD
	J3L14AV	1TB 7200 RPM SATA 3rd HDD
	J3L20AV	256GB SATA 3rd SSD
	J3L36AV	500GB 7200 RPM SATA 4th HDD
	J3L37AV	1TB 7200 RPM SATA 4th HDD
	J3L43AV	256GB SATA 4th SSD
	J3L54AV	500GB 7200 RPM SATA 5th HDD
	J3L55AV	1TB 7200 RPM SATA 5th HDD
	J3L61AV	256GB SATA 5th SSD
	J3L69AV	256GB SATA 6th SSD
	J3L75AV	256GB SATA 7th SSD
Graphics	Product #	Offering
	F5G75AV	NVIDIA NVS 310 512MB 1st GFX
	J1Q20AV	NVIDIA Quadro K2200 4GB 1st GFX
	J1Q21AV	NVIDIA Quadro K4200 4GB 1st GFX
	J1Q24AV	AMD FirePro W2100 2GB 1st GFX
	J1Q27AV	NVIDIA NVS 310 512MB 2nd GFX
	J1Q31AV	NVIDIA Quadro K2200 4GB 2nd GFX
	J1Q32AV	NVIDIA Quadro K4200 4GB 2nd GFX
	J1Q35AV	AMD FirePro W2100 2GB 2nd GFX
	J1Q38AV	NVIDIA Quadro K2200 4GB 3rd GFX
Memory	Product #	Offering
	G8X58AV	8GB DDR4-2133 (1x8GB) 1CPU RegRAM
	G8X61AV	16GB DDR4-2133 (2x8GB) 1CPU RegRAM
	G8X63AV	32GB DDR4-2133 (4x8GB) 1CPU RegRAM
	G8X74AV	32GB DDR4-2133 (4x8GB) 2CPU RegRAM
	G8X64AV	64GB DDR4-2133 (8x8GB) 1CPU RegRAM
	G8X77AV	64GB DDR4-2133 (8x8GB) 2CPU RegRAM
	G8X65AV	64GB DDR4-2133 (4x16GB) 1CPU RegRAM
	G8X78AV	128GB DDR4-2133 (16x8GB) 2CPU RegRAM
	G8X66AV	128GB DDR4-2133 (8x16GB) 1CPU RegRAM
	G8X79AV	128GB DDR4-2133 (8x16GB) 2CPU RegRAM
	G8X80AV	256GB DDR4-2133 (16x16GB) 2CPU RegRAM
Optical and Removable	Product #	Offering
Storage	F5G79AV	Slim SuperMulti DVDRW SATA 1st ODD
	G8U90AV	Slim SuperMulti DVDRW SATA 2nd ODD
Input Devices	Product #	Offering
	G8U76AV	HP USB Keyboard
	G8U87AV	HP USB Optical Mouse



Technical Specifications - Processors

PROCESSORS

Xeon E5-2603 v3 1.6 1600 6C CPU	J9V77AA
Xeon E5-2609 v3 1.9 1600 6C CPU	J9V76AA
Xeon E5-2620 v3 2.4 1866 6C CPU	J9V75AA
Xeon E5-2623 v3 3.0 1866 4C CPU	J9Q18AA
Xeon E5-2630 v3 2.4 1866 8C CPU	J9Q17AA
Xeon E5-2640 v3 2.6 1866 8C CPU	J9Q16AA
Xeon E5-2637 v3 3.5 2133 4C CPU	J9Q15AA
Xeon E5-2650 v3 2.3 2133 10C CPU	J9Q14AA
Xeon E5-2660 v3 2.6 2133 10C CPU	J9Q13AA
Xeon E5-2643 v3 3.4 2133 6C CPU	J9Q12AA
Xeon E5-2670 v3 2.3 2133 12C CPU	J9Q11AA
Xeon E5-2680 v3 2.5 2133 12C CPU	J9Q10AA
Xeon E5-2683 v3 2.0 2133 14C CPU	J9Q09AA
Xeon E5-2667 v3 3.2 2133 8C CPU	J9Q08AA
Xeon E5-2690 v3 2.6 2133 12C CPU	J9Q07AA
Xeon E5-2687Wv3 3.1 2133 10C CPU	J9Q06AA
Xeon E5-2695 v3 2.3 2133 14C CPU	J9Q05AA
Xeon E5-2697 v3 2.6 2133 14C CPU	J9Q04AA
Xeon E5-2699 v3 2.3 2133 18C CPU	J9Q03AA



Technical Specifications – Storage Hard Drives

HARD DRIVES

HP SAS (Serial Attached
SCSI) Hard Drives for HP
Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 600GB
Height 1 in; 2.54 cm
Width Media Diameter

Vidth Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msFull Stroke6.6 ms

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity300GBHeight1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s
Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 ms
3.4 msFull Stroke6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

HP 300GB SAS 10K SFF HDD Capacity300GBHeight0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s
Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controller overhead, including settling)Single Track o.4 ms (max)Average stll Stroke3.6 msFull Stroke7.3 ms

Technical Specifications – Storage Hard Drives

Rotational Speed 10,000 rpm **Logical Blocks** 585,937,500

Operating Temperature 41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF

HDD

600GB Capacity

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in: 6.36 cm **Physical Size** 2.75 in; 6.99 cm

SAS 6Gb/s Interface **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

settling)

Buffer 64MB

Cache multi-segmentable cache buffer **Seek Time** (typical reads, **Single Track** 0.4 ms (max) includes controller Average 3.6 ms overhead, including **Full Stroke** 7.3 ms

Rotational Speed 10,000 rpm **Logical Blocks** 1,172,123,568

Operating Temperature 41° to 131° F (5° to 55° C)

HP 1.2TB SAS 10K SFF HDD

1.2TB Capacity Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Average

Full Stroke

Interface SAS 6Gb/s Up to 600MB/s **Synchronous Transfer**

Rate (Maximum)

Buffer

64MB **Seek Time** (typical reads, **Single Track**

includes controller overhead, including

settling)

Rotational Speed 10,000 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

Logical Blocks 2,344,225,968

SATA Hard Drives for HP Workstations

500GB SATA 10K rpm SFF Capacity **HDD**

500GB Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) Up to 600MB/s

Synchronous Transfer Rate (Maximum)

Buffer 64MB Cache Adaptive 0.18ms (max)

3.5ms

7.17ms

21ms (typical)

Technical Specifications – Storage Hard Drives

Seek Time (typical reads, **Single Track** 1.2ms (typical) includes controller Average 3.6ms overhead, including 9.0ms (typical)

Full Stroke settling)

Rotational Speed 10K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1TB

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6Gb/s) **Synchronous Transfer** Up to 600 MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, **Single Track** 1.2ms (typical) includes controller Average 11ms overhead, including **Full Stroke**

settling) **Rotational Speed** 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2.0TB Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm Interface Serial ATA (6.0 Gb/s), NCO Enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads. **Single Track** 1.0 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 18 ms settling)

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 3.0TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Up to 6.0 Gb/s

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Technical Specifications – Storage Hard Drives

Seek Time (typical reads, **Single Track** 0.6 ms includes controller Average 11 ms overhead, including **Full Stroke Not Specified**

settling)

Rotational Speed 7,200 rpm

Operating Temperature 41° to 140° F (5° to 60° C)

500GB SATA 7.2K SED SFF Capacity 500GB

settling)

HDD Height 0.275 in; 0.7 cm

> Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s)

Synchronous Transfer Up to 600MB/s Rate (Maximum)

Buffer 32MB

Seek Time (typical reads, **Single Track** 1ms includes controller Average 4.2ms overhead, including **Full Stroke** 25ms (typical)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

HP Solid State Drives (SSDs) for Workstations SSD

HP 128GB SATA 6Gb/s Capacity 128GB Height 0.28 in; 0.7 cm

> Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s

SSD

Capacity 256GB

Height 0.28 in; 0.7 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Opal 1SSD

Capacity 256GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s Capacity 512GB

Technical Specifications – Storage Hard Drives

SSD	Uoight	0.30 in 0.7 cm	
חככ	Height Width	0.28 in; 0.7 cm	2.5 in 6.26 am
	width Interface	Physical Size	2.5 in; 6.36 cm
		6Gb/s SATA	atial Dand\
	Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Seque	itial Kead)
	Operating Temperature	32° to 158° F (0° to 70°	(C)
HP 1TB SATA 6Gb/s SSD	Capacity	1TB	
	Height	0.28 in; 0.7 cm	
	Width	Physical Size	2.5 in; 6.36 cm
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)	
	Operating Temperature	32° to 158° F (0° to 70°	(C)
Samsung Enterprise	Capacity	240GB	
240GB SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer	600 Mb/s	
	Rate (Maximum)		
Samsung Enterprise	Capacity	480GB	
480GB SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
	Interface	SATA 6Gb/s	
	Synchronous Transfer	600 Mb/s	
	Rate (Maximum)		
Intel Pro 1500 180GB	Capacity	180GB	
SATA SSD	Width	Physical Size	2.5 in; 6.36 cm
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	600 Mb/s	
	Operating Temperature	32° to 158° F (0° to 70°	C)
HP Z Turbo Drive 256GB	Capacity	256GB	
SSD	Interface		trical v4 physical
		PCI Express 2.0 x4 elec	· ·
	Operating Temperature	32° to 158° F (0° to 70	C)
HP Z Turbo Drive 512GB	Capacity	512GB	
SSD	Interface		etrical vA physical
-		PCI Express 2.0 x4 election 32° to 158° F (0° to 70	
	Operating Temperature	32 10 136 F (U 10 /U	C)



PCIe SSDs for HP Workstations

Technical Specifications - Hard Drive Controllers

LSI 9270-8i SAS 6Gb/s PCI Bus ROC RAID Card and iBBU9 RAID Levels Battery Backup Unit

PCI Bus x8 lane PCIe 3.0 compliant

RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Card Type Low profile, single PCIe slot design with full height bracket.

PCI Voltage +3.3V Add-in Card
PCI Power +3.3V, +12V
Certification Level PCI-Express 3.0

10 Bus Eight 6Gb/s and 3Gb/s compatible SAS/SATA ports

SAS Processor LSISAS2208 Dual-Core RAID on Chip (ROC)

Internal Connectors Two SAS SFF8087 x4 (Mini-SAS)

External Connectors None

Maximum Number of SCSI Up to 128 SAS and/or SATA hard drives and SSDs

Devices Note: HP Workstations do not support this many internal drives.

LED Indicators Heartbeat LED on card



GRAPHICS

NVIDIA NVS 310 512MB Graphics **Form Factor** Low Profile:

2.7 inches (H) x 5.7 inches (L), Half-Height

Weight: ~142 grams

Graphics Controller NVIDIA NVS 310

GPU: GF119-825

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875MHz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort

Maximum Resolution Up to 2560 x 1600 (digital display) per display.

Image Quality Features

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

H.264 SVC codec supportSupport for 3D Blu Ray

VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60
 Hz with reduced blanking using DisplayPort to DVI-D single-link
 cable adaptors
- Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors



VGA display output:

Drives two analog display at resolutions up to 1920 × 1200 at 60

Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics APIs DX11, OpenGL 4.1

Shader Model 5.0

Available Graphics Drivers

Windows 8

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NOTES:

1. The thermal solution used on this card is an active fan heatsink.

2. Factory configured NVS 310 graphics card have no cable adapters included. Adapters must be ordered separately.

3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

NVIDIA NVS 315 512MB Graphics

Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 315 (using GF119-825 GPU)

Number of Cores: 48 CUDA cores

Max. Power: 19.3W

Cooling Solution: Active fan heatsink PCI Express x16, 2.0 compliant

Size: 1GB DDR3 Memory

Bus Type

Clock: 875MHz

Memory Bandwidth: 14GB/s

Connectors DMS-59 output

Cables included:

- For CTO: DMS-59 to DVI cable

For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable

Maximum Resolution Maximum number of displays supported: 2

Maximum Resolution Support:

- DMS-59 to VGA: 2048 x 1536 @ 85Hz - DMS-59 to DVI: 1980 x 1200 @ 60Hz - DMS-59 to DP: 2560 x 1600 @ 60Hz

Image Quality Features See Display Output section.

The following video formats are supported:



- MPEG2
- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support
- Support for 3D Blu Ray
- VC1
- DivX version 3.11 or later

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays using one of the following DMS-59 cables:

- DMS-59 to DVI
- DMS-59 to VGA
- DMS-59 to DP

DisplayPort output:

Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.

DVI-D output:

Drives two digital displays at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor

VGA display output:

Drives two analog displays at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.

Shading Architecture Supported Graphics APIs DX11, OpenGL 4.3

Shader Model 5.0

Available Graphics Drivers

Windows 8

Microsoft Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NOTES:

- 1. The thermal solution used on this card is an active fan heatsink.
- 2. Factory configured graphics card includes DMS-59 to DVI cable.
- 3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA cables (one each).



NVIDIA NVS 510 2GB Graphics

Form Factor Low Profile, 2.713 inches × 6.3 inches, single slot

Graphics Controller NVS 510 GPU Core Clock: 797 MHz

Memory Clock: 891 MHz
CUDA Cores: 192

Bus Type PCI Express x16, Generation 2.0

Memory 2GB DDR3

Connectors Four mini-DisplayPort.

Four mini-DisplayPort to DisplayPort adapters included.

(DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)

Maximum Resolution Mini-DisplayPort connectors support ultra-high-resolution panels (up to

3840 x 2160 @ 60Hz)

NOTE: This card supports up to four displays. For Windows XP, only 2 active displays are supported.

Image Quality Features

10-bit internal display processing, including hardware support for 10-bit

scan-out

Display Output

DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2) support.

Digital Display Support

1. DisplayPort Output

- Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.
- DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology – up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

2. DVI-D Output

- Drives four digital displays at resolutions up to 1920 × 1200 at 60
 Hz with reduced blanking using DisplayPort to DVI-D single-link
 cable adaptors.
- Drives four digital displays at resolutions up to 2560× 1600 at 60
 Hz with reduced blanking using DisplayPort to DVI-D dual-link
 cable adaptors.

HDMI Output

 The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.

Analog Display Support

1. VGA display output

Drives four analog displays at resolutions up to 1920 × 1200 at 60
 Hz using DisplayPort to VGA cable adaptors.



Technical Specifications – Graphics

Supported Graphics APIs Full Microsoft DirectX 11, Shader Model 5.0 support

Full OpenGL 4.3 support

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NOTE: Heatsink cooler design is active.

Graphics Cable Adapters Graphics Cable Adapter option choice is available starting Feb 1 2013 for

the following graphics cards:

NVS 310, Quadro 410, Quadro K5000, FirePro V3900, FirePro W7000

New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing Graphics Cable Adapters, unless otherwise specified.

No cable choice for NVS 300, NVS 510.

Maximum number of cables allowed is 8.

NVIDIA Quadro K620 2GB Form Factor

Graphics

2.713" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

Weight: 133 grams

Graphics Controller NVIDIA Quadro K620 Graphics Card

GM107 GPU 384 CUDA cores

Max Power: 45 Watts

Max Power. 45 Walls

Bus Type PCI Express 2.0 x16
Memory 2 GB GDDR3, 900 MHz

128-bit memory I/O path

29 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 1 DisplayPort output

Factory Configured: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as Factory Configuration or Option Kit accessories.

Maximum Resolution DisplayPort 1.2:

- up to 4096x2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Dual Link DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:



up to 1920 x 1200 x 32 bpp @ 60Hz

10-bit internal display processing pipeline **Image Quality Features**

10-bit scan-out support

Display Output 1 Dual-link DVI-I connector

1 Display Port connector

Shading Architecture

Full Microsoft DirectX 11.1 Shader Model 5.0

Supported Graphics APIs OpenGL 4.4

DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

1. Factory configured Quadro K620 does not include a video cable adapter. Video cable adapters must be ordered separately.

2. Quadro K620 offered as an Option Kit (AMO) includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

NVIDIA Ouadro K420 1GB Form Factor **Graphics**

2.713 inches × 6.3 inches, single slot

Graphics Controller

NVIDIA Ouadro K420

GPU: GK107

PCI Express x16, 2.0 compliant

Bus Type Memory

Size: 1GB DDR3

Low Profile:

Clock: 891MHz

Connectors

Memory Bandwidth: 29GB/s One dual-link DVI-I connector

One DisplayPort connector

Maximum Resolution

VGA (via adapter cable):

2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

3840 × 2160 × 30 bpp at 60 Hz

RAMDAC 400 MHz integrated RAMDAC

Display Output Maximum number of displays supported: 2

Shading Architecture Shader Model 5.0

Supported Graphics APIs DX11, OpenGL 4.4

Programming support for CUDA C, CUDA C++, DirectCompute 5.0, OpenCL,

Python, and Fortran

Available Graphics Drivers

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

 Factory configured Quadro K420 does not include any video adapters. Adapters must be ordered separately.

2. Option kit Quadro K420 includes one DP to DVI-D adapter.

NVIDIA Quadro K2200 2GB Graphics **Form Factor** 4.38" H x 7.97" L

Single Slot, Full Height

Weight: 240 grams

Graphics Controller NVIDIA Quadro K2200 Graphics Card

GM107 GPU 640 CUDA cores Max Power: 67.7 Watts

Bus Type PCI Express 2.0 x16

Memory 4 GB GDDR5, 2500 MHz
128-bit memory I/O path

80 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 2 DisplayPort outputs

Factory Configured Option: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution

DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (via adapter cable):

- 2048 × 1536 × 32 bpp at 85 Hz

Image Quality Features 12-bit internal display pipeline

(hardware support for 12-bit scan-out on supported panels, applications

and connection)

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology,

3D DLP, Interleaved, and passive stereo

Display Output Maximum number of displays

- 3 direct attached monitors

- 4 using DP 1.2a with MST and HBR2 enabled monitors

Maximum number of DisplayPort displays possible (may require MST

and/or HBR2):

-41920x1200

- 4 2560x1600

- 2 4096x2160

Maximum number of monitors across all available Quadro K2200 outputs

is 4.

Shading Architecture

Full Microsoft DirectX 11.1 Shader Model 5.0

Supported Graphics APIs

OpenGL 4.4 DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Microsoft Windows 8.1 Microsoft Windows 8 Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

 Quadro K2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.

 Quadro K2200 offered as an Option Kit includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

 A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays or a DisplayPort 1.2 hub device.

 A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K2200 DisplayPort output.

NVIDIA Quadro K4200 4GB Form Factor Graphics

4.376" H x 9.5" L

Single Slot, Full Height

Weight: ~461 grams (without extender)

Graphics Controller

NVIDIA Quadro K4200 Graphics Card

Kepler GK104 GPU 1344 CUDA cores Max Power: 108 Watts PCI Express 2.0 x16

Bus Type Memory

Connectors

4 GB GDDR5, 2700 MHz 256-bit memory I/O path

173 GB/s memory bandwidth
1 DL-DVI(I)

2 DisplayPort 1.2a

E DISPLAYFULL 1.2a

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Technical Specifications – Graphics

Maximum Resolution

DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (via adapter cable):

- 2048 × 1536 × 32 bpp at 85 Hz

Image Quality Features

10-bit internal display processing (hardware support for 10-bit scanout for both windowed desktop and full screen, only available on Windows with Aero disabled and Linux)

NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL quad buffered stereo support

Support for large-scale, ultra-high resolution visualization using the NVIDIA® SVS platform which includes NVIDIA® Mosaic, NVIDIA® Sync and NVIDIA® Warp/Blend technologies

Display Output

Maximum number of displays

- 3 direct attached monitors

- 4 using DP 1.2a with MST and HBR2 enabled monitors

Maximum number of DisplayPort displays possible (may require MST

and/or HBR2): -41920x1200 - 4 2560x1600 - 2 3840x2160

Maximum number of monitors across all available Quadro K4200 outputs

is 4.

Shading Architecture

Shader Model 5.0 Supported Graphics APIs OpenGL 4.4

DirectX 11.1

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Microsoft Windows 8.1 Microsoft Windows 8

Microsoft Windows 7

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NOTES:



Quadro K4200 offered as CTO does not include a video cable adapter.

Video cable adapters must be ordered separately.

Quadro K4200 offered as AMO includes one DP-to-DVI video cable adapter.

Additional cables must be ordered separately.

A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained

DisplayPort 1.2 displays or a DisplayPort 1.2 hub device.

A DisplayPort hub device may be used to connect multiple DisplayPort

monitors to a single Quadro K4200 DisplayPort output.

NVIDIA Quadro K5200 8GB Dimensions

Graphics

4.376" H x 10.5" L

Dual Slot

Weight: ~880 grams (without extender)

Graphics Controller NVIDIA Quadro K5200

GPU: GK110-850-B1 with 2304 CUDA cores

Power: 150 Watts

Bus Type PCI Express 3.0 x16 **Memory** Size: 8GB GDDR5

Memory bandwidth: 192GB/s Memory Width: 256-bit

Connectors DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to

Dual-Link DVI adapters available as accessories.

Maximum Resolution

DisplayPort:

- up to 4096 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (via adapter cable):

- 2048 × 1536 × 32 bpp at 85 Hz

Image Quality Features

10-bit internal display processing (hardware support for 10-bit scanout for both windowed desktop and full screen, only available on Windows

with Aero disabled and Linux).

NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo

format support.

Full OpenGL quad buffered stereo support.

Support for NVIDIA® Quadro® Mosaic, NVIDIA® nView® multi-display



technology, NVIDIA® Enterprise Management Tools.

Support for large-scale, ultra-high resolution visualization using the NVIDIA® SVS platform which includes NVIDIA® Mosaic, NVIDIA® Sync and

NVIDIA® Warp/Blend technologies.

Display Output Maximum number of displays

- 4 direct attached monitors

- 4 using DP 1.2a with MST and HBR2 enabled monitors

Maximum number of DisplayPort displays possible (may require MST

and/or HBR2): - 4 1920x1200 - 4 2560x1600 - 2 4096x2160

Maximum number of monitors across all available Quadro K5200 outputs

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

OpenGL 4.4 DirectX 11

API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0, OpenCL,

Java, Python, Fortran

Available Graphics

Drivers

Windows 8.1 Windows 8

Windows 7

Linux - Full OpenGL implementation, complete with NVIDIA and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NOTES:

1. Factory configured Quadro K5200 does not include a video cable adapter. Video cable adapters must be ordered separately.

2. A total maximum of 4 active monitors are supported across all display output types. This may be accomplished by using daisy chained DisplayPort 1.2 displays (displays must support MST and HBR2).

NVIDIA Quadro K6000 12GB Graphics

Form Factor

Weight:

4.376" H x 10.5" L

Dual Slot

Power: 234 Watts ~880 grams

Graphics Controller

NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz



Technical Specifications – Graphics

Bus Type PCI Express 3.0 x16

Memory 12GB GDDR5

384-bit memory I/O path 288 GB/s memory bandwidth

ECC Memory

Connectors DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-

Link DVI adapters available as accessories.

Image Quality Features

DisplayPort with Multi-Stream Technology (MST) and High Bit Rate
 2 (HBR2), HDMI 1.4, and HDCP support

NVIDIA 3D Vision™ technology

NVIDIA Premium Mosaic and nView

Display Output 400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 ×

1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

• Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Shading Architecture Shader Model 5.0

Full IEEE 764-2008 32-bit and 64-bit precision

Supported Graphics APIs Full OpenGL 4.3

Full DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Windows 8

Drivers Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NOTES:

NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000

to enable direct mapping of GPU to Virtual Machine.

No display output adapter included.

AMD FirePro W2100 2GB Form Factor **Graphics**

Low Profile, half length (full-height bracket included)

Graphics Controller

AMD FirePro™ W2100 professional graphics based on Oland GPU. GPU: 320 Stream Processors organized into 5 Compute Units

GPU Frequency: 630MHz

Power: 35W Cooling: Active

Bus Type PCI Express® x8, Generation 3.0

Memory 2GB DDR3 memory

Memory Bandwidth: 28.8 GB/s

Memory Width:128bit

Connectors 2x Display Port 1.2 connectors

> Factory Configured: No video cable adapter included Option Kit: One DP-to-DVI adapter included with card

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available

as Factory Configuration or Option Kit accessories.

Maximum Resolution

DisplayPort 1.2:

up to 4096x2160 x 30 bpp @ 60Hz

Dual Link DVI(I) (requires adapter cable): up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I)(requires adapter): up to 1920 x 1200 x 32 bpp @ 60Hz

VGA(requires adapter):

up to 1920 x 1200 x 32 bpp @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling.

Display Output 2 x DisplayPort® 1.2

Maximum number of displays: 2

Shading Architecture Shader Model 5.0

Supported Graphics APIs OpenCL™ 2.0, DirectX® 11.2/12 and OpenGL 4.4

Available Graphics Windows 8.1 (64-bit and 32-bit)

Technical Specifications – Graphics

Drivers Windows 7 (64-bit and 32-bit)

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NOTE: Depending on the card model, native DisplayPort[™] connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See http://www.amd.com/firepro for details

AMD FirePro W5100 4GB Form Factor Graphics

Full height, full length, single slot (6.75" X 3.75")

Graphics Controller

AMD FirePro W5100 graphics based on the "Bonaire" GPU

GPU Frequency: 1000MHz

GPU: 768 Stream Processors organized into 12 Compute Units

Power: <75 Watts Cooling: Active

PCI Express® x16, Generation 3.0 **Bus Type**

Memory 4GB GDDR5 memory

Memory Bandwidth: 96 GB/s Memory Width: 128bit

Connectors 4x Display Port 1.2 connectors with HBR2 and MST support.

Factory Configured: No video cable adapter included

After market option kit: One DP-to-DVI adapter included with card

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available

as Factory Configuration or Option Kit accessories.

Maximum Resolution

DisplayPort:

- 4096x2160 @24bpp 60Hz

Dual Link DVI:

- 2560x1600 (requires DP to DL-DVI adapter)

Single Link DVI:

- 1920x1200 (requires DP to DVI adapter)

VGA:

- 1920x1200 (requires DP to VGA adapter)

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling

Display Output Max number of monitors supported using DisplayPort 1.2a:

- 4 direct attached monitors

- 6 using DP 1.2a with MST and HBR2 enabled monitors

Monitor chaining from a single DisplayPort (subject to a max of 6 total monitors across all outputs, requires use of DisplayPort enabled monitors

supporting MST and HBR2): - one 4096x2160 display - two 2560x1600 displays

four 1920x1200 displays

Shading Architecture Shader Model 5.0 Supported Graphics APIs OpenGL 4.4v



Technical Specifications – Graphics

OpenCL 2.0vi DirectX 11.2 / 12 AMD Mantle

Available Graphics Drivers Windows 8.1 / 8 (64-bit and 32-bit) Windows® 7 (64-bit and 32-bit)

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim SuperMulti DVD Writer Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD-RAM

> DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD < 200 ms (seek) **Full Stroke CD** < 200 ms (seek)

Maximum Data Transfer Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD-RAM Up to 8X

> DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC -< 800 mA typical, <1600 mA

> > maximum

Operating Environmental Temperature

(all conditions non-

Operating Systems

condensing)

Supported

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

Technical Specifications - Optical and Removable Storage

Kit Contents 9.5mm Slim SuperMulti DVD Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

HP 9.5mm Slim DVD-ROM Description Drive

Mounting Orientation

9.5mm height, tray-load

Either horizontal or vertical

Interface Type

SATA / ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

Disc Capacity

DVD-ROM

Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times DVD-ROM Single Layer

> CD-ROM Mode 1 Full Stroke DVD Full Stroke CD

DC Power Requirements

< 230 ms (typical) < 220 ms (typical)

< 110 ms (typical) < 110 ms (typical)

Power Source

SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p

DC Current

5 VDC - <800mA typical, < 1600 mA

maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80%

Operating Systems Supported

Maximum Wet Bulb Temperature 84° F (29° C)

Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

HP 9.5mm Slim BDXL Blu- Description **Ray Writer**

9.5mm height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA/ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

Supported Media Types

BD-ROM BD-R

> **BD-RE DVD-RAM** DVD+R DVD+RW DVD+R DL DVD-R DL



Technical Specifications - Optical and Removable Storage

DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Blu-ray 25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek)
Full Stroke CD < 220 ms (seek)

Blu-ray < 230 ms (seek) (Full Stroke Blu-ray)
Startup Time (Time to drive ready from tray

loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S

DVD-RW 25S

DVD+R (SL/DL) 25S / 25S

DVD+RW 25S DVD-RAM 45S CD-ROM 15S

CD-RW Up to 24X

Maximum Data Transfer CD ROM Read CD-ROM, CD-R Up to 24X

Rates

DVD ROM Read DVD-RAI

DVD-RAM Up to 8X
DVD+RW Up to 8X
DVD-RW Up to 8X
DVD+R DL Up to 8X
DVD-R DL Up to 8X
DVD-ROM Up to 8X
DVD-ROM DL Up to 8X
DVD-ROM DL Up to 8X
DVD-R Up to 8X
DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p
DC Current 5 VDC -900 mA typical, 2000mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity
10% to 80%
Maximum Wet Bulb Temperature
84° F (29° C)

Operating Systems Windows 8.1, Windows 8.32-bit and 64-bit, Windows 7 Professional 32-bit

Technical Specifications - Optical and Removable Storage

Supported and 64-bit,

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP DX115 Removable Drive Enclosure

Interface Type

Compatible with SAS or SATA controllers. Offers 6Gb/s performance when

used with 6Gb/s HDDs.

Dimensions (WxHxD)

(WALIAD)

147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in) Frame and Carrier: 1.73 kg (3.8 lbs.)

Carrier: 0.45 kg (1 lbs.)

HP 15-in-1 Media Card Reader Description

Weight

Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode Supports MS-PRO 4-bit parallel transfer mode Supports MS PRO-HG Duo 4-bit parallel transfer mode Supports SD 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode
Supports UHS-104 SD 4-bit card (version 3.0)

Supports CF v6.0 with PIO mode 6 and Ultra DMA 7 mode

Interface Type USB 3.0 High-speed interface

NOTE: If there is a USB2 connection, USB2 transfer speeds are supported.

Dimensions (WxHxD) 4.9 x 4 x 1 in (124.5 x 101.6 x 25.4 mm) Fits conveniently in the 5.25" drive

bay.

Supported Media Types

CompactFlash Type I

CompactFlash Type II

Microdrive

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)
SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

Memory Stick
Memory Stick Select
Memory Stick Duo (MS Duo)
Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo MagicGate Memory Stick (MG)



Technical Specifications - Optical and Removable Storage

MagicGate Memory Stick Duo

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Test Parameters/Conditions - Power applied, unit operating on system

±5%

Operating Systems
Supported

Windows 8 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 8 (64-bit)*

Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**
Windows Vista Business 64
Windows Vista Business 32
Windows Vista Home Basic 32
Windows XP Professional
Windows XP Home 32

No driver is required for this device. Native support is provided by the

operating system.

Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See

http://www.microsoft.com.

Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full

advantage of Windows 7 functionality.

Seehttp://www.microsoft.com/windows/windows-7/ for details.

Kit Contents Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security

Software and Documentation CD

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Weight 0.35 lbs. (0.16 kg)



Technical Specifications - Controller Cards

CONTROLLER CARDS

HP IEEE 1394b FireWire PCIe Card

Data Transfer RateSupports up to 800 Mb/sDevices SupportedIEEE-1394 compliant devicesBus TypePCIe card full height PCIe slots

Ports Two IEEE-1394b external 9-Pin connectors (Rear)

Internal Connectors One 10-Pin header connector

System Requirements Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit, SLED 11

and RHEL 6. Intel i5 series or higher processor, min 2GB of RAM, 20GB Hard

Drive, CD-ROM drive, built in sound system, Available PCIe slot.

Temperature – Operating 50° to 131° F (10° to 55° C)

Temperature – Storage -22° to 140° F (-30° to 60° C)

Relative Humidity –

Operating

20% to 80%

Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 8.1 64-bit, Windows 7 Professional 32-bit and 64-bit

HP Thunderbolt-2 PCIe 1- Data Transfer Rate port I/O Card Devices Supported

Data Transfer RateSupports up to 20 Gb/s (20,000 Mb/s)Devices SupportedThunderbolt™ certified devices

Bus Type PCIe card, full or half height PCIe slots

Ports One Thunderbolt™ 2 external 20-Pin output connectors (Rear)

One full size DisplayPort input connector (Rear)

Internal Connectors One 5-Pin header connector

System Requirements Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel

i5 series or higher processor, 4-GB RAM, 20-GB Hard Drive, available PCIe

slot.

Temperature - Operating 50° to 131° F (10° to 55° C)

Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.

Kit Contents HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height

bracket, DisplayPort to DisplayPort cable, internal header cables (2), user

documentation and warranty card.

Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS

HP X520 10GbE Dual Port Hardware Certifications FCC B, UL, CE, VCCI, BSMI, CTICK, KCC

Adapter

Transceiver

HP 10GbE SFP+ SR Operating Temperature 0C to 45C

(32F to 113F)

Operating Humidity 0% to 85%, noncondensing **Dimensions** (H x W x D) 0.47(h) x 0.54(w) x 2.19(d)inches

(1.19 x 1.38 x 5.57 cm)

Intel 7260 802.11 a/b/g/n PCIe WLAN NIC **Operating Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Dimensions (H x W x D) Native HMC: 26.8 x 30.0 x 2.4 mm

Carrier Card Assembly 3.3 x 4.7 in (84 x 119 mm)

Kit Contents PCIe x1 card with full height bracket, rf antenna, antenna cable, separate

low profile bracket, software CD and warranty.

NOTES:

 WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Check latest software/driver release for updates on supported security features.

3. Maximum output power may vary by country according to local regulations.

4. In Power Save Polling mode and on battery power.

Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for

802.11a/g (OFDM modulation).

Integrated Intel I210AT PCIe GbE Controller

Connector RJ-45 (motherboard integration)

Controller Intel I210 GbE platform LAN connect networking controller

Memory Programmable FIFO packet buffer memory

Tx 24KB default Rx up to 16KB

Data Rates Supported

10/100/1000 Mbps

Compliance 802.1as. 802.1g. 8

802.1as, 802.1q, 802.1Q, 802.3, 802.3ab, 802.3ap, 802.3az, 802.3u,

802.3x, 802.3z

Bus Architecture PCI Express 2.1 (x1) and SMBus

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

Power Requirement Requires 3.3V only (integrated regulators)

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps



Technical Specifications - Networking and Communications

1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable

diagnostics

Integrated Intel I218LM PCIe GbE Controller

Connector RJ-45 (motherboard integration)

Controller Intel I218LM GbE platform LAN connect networking controller

Memory 3 KB FIFO packet buffer memory (both Tx and Rx)

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1as, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3x,

802.3z

Bus Architecture PCI Express 1.1 (x1) and SMBus

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

Power Requirement Requires 3.3V only (integrated regulators)

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable

diagnostics

AMT 9.1 support, vPro compliant

HP 361T PCIe Dual Port Gigabit NIC

Connector Two RJ-45

Controller Intel® Ethernet I350 Controller

Data Rates Supported

Compliance

10/100/1000 Mbps, Half- and full-duplex

802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az, IEEE

1588

PCIe v2.0 standard RoHS (6 of 6) FCC (U.S. only) Class B DOC (Canada) Class B

CE EN 55024, EN55022 Class B

VCCI Class II UL 1950 CSA 950 EN 60950 CE ACPI 1.1a

Microsoft WHQL (Windows Hardware Quality Labs)

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express

slots

Power Requirement 4.1W idle without EEE link partner

3.2W idle with EEE link partner

4.2W maximum

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s

Technical Specifications - Networking and Communications

100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature 32° to 131° F (0° to 55° C) **Operating Humidity** 10% to 95% non-condensing

Dimensions $(H \times W \times D)$ 5.3 x 2.5 in (13.50cm x 6.4 cm) (without brackets) **Operating System Driver** Windows 7 Professional 32-bit and 64-bit.

Support

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Kit Contents HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket

attached to it (the low profile bracket is included in the clamshell that the

PCA ships in)

Product Warranty statement and the Quick Install Card (QIC).



Summary of Changes

SUMMARY OF CHANGES

Date of change:	Version History:		Description of change:
August 21, 2014	v1	Added	Style and technical specifications
October 24, 2014	From v1 to v2	Added	note to supported components: memory, Foxit PhantomPDF Express and Cyberlink Power2Go: software, Optical drives: DVD, BD-XL specs
November 1, 2014	From v2 to v3	Added	Note for Internal USB connector conversion, Overview
		Changed	ChangedInternal USB statement in Overview and System Board sections



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